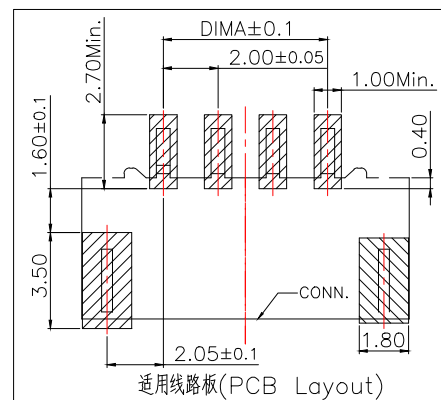
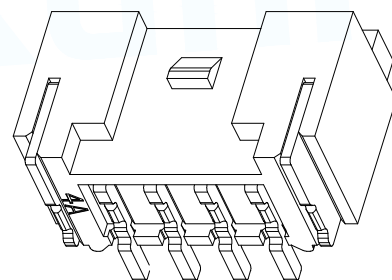
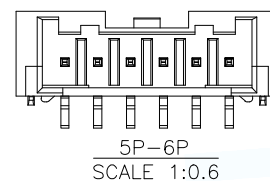
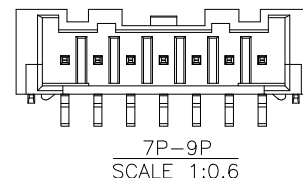
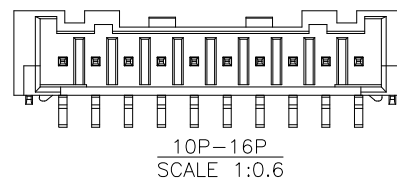
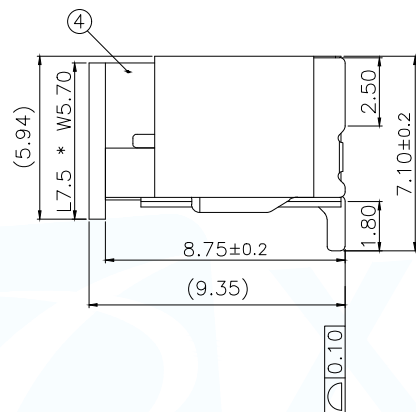
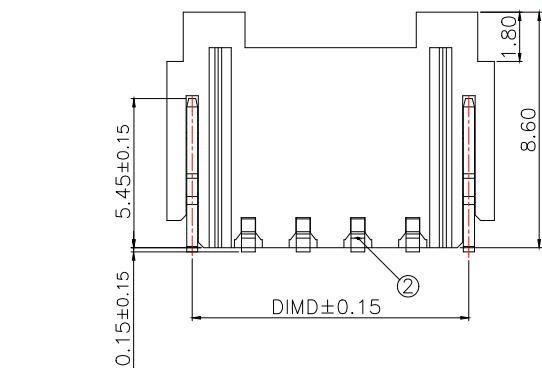
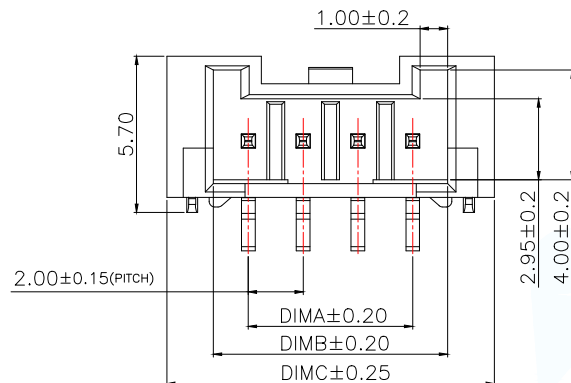
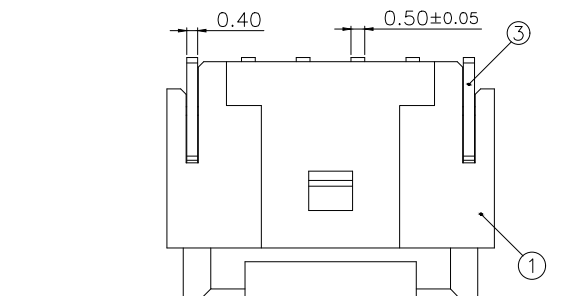




技术指标(Technical Index):

1. 塑件表面应光洁、无毛边、无明显收缩、缺陷、裂纹等现象。
(The surface of the plastic parts should be smooth, no rough edges, no obvious shrinkage, defects, cracks and other phenomena)
2. 工作温度(Temperature range): -25°C~+85°C.
3. 额定电压(Rated voltage): 250V, AC/DC.
4. 额定电流: 3.0A, AC/DC.
5. 接触电阻(Contact resistance): ≤20mΩ.
6. 绝缘电阻(Insulation resistance): ≥1000MΩ.
7. 耐电压(Withstanding Voltage): 800V AC/minute.

Part No	CKT	A	B	C	D
PA2.0-2PLT-MR	2	2.00	4.55	7.95	6.10
PA2.0-3PLT-MR	3	4.00	6.55	9.95	8.10
PA2.0-4PLT-MR	4	6.00	8.55	11.95	10.10
PA2.0-5PLT-MR	5	8.00	10.55	13.95	12.10
PA2.0-6PLT-MR	6	10.00	12.55	15.95	14.10
PA2.0-7PLT-MR	7	12.00	14.55	17.95	16.10
PA2.0-8PLT-MR	8	14.00	16.55	19.95	18.10
PA2.0-9PLT-MR	9	16.00	18.55	21.95	20.10
PA2.0-10PLT-MR	10	18.00	20.55	23.95	22.10
PA2.0-11PLT-MR	11	20.00	22.55	25.95	24.10
PA2.0-12PLT-MR	12	22.00	24.55	27.95	26.10
PA2.0-13PLT-MR	13	24.00	26.55	29.95	28.10
PA2.0-14PLT-MR	14	26.00	28.55	31.95	30.10
PA2.0-15PLT-MR	15	28.00	30.55	33.95	32.10
PA2.0-16PLT-MR	16	30.00	32.55	35.95	34.10

序号	品名	材质
①	2.0 R型卧式WTB胶芯 2.0 Pitch R/A Wire To Board Housing(H=5.7)	PA6T UL94V-0 米黄色 LCP UL94V-0 本色
②	2.0 R型立式WTB端子 2.0 Pitch S/T Wire To Board Terminal(H=8.7)	铜合金/表面镀锡 Copper Alloy/ Tin Plating
③	2.0 R型卧式WTB焊片 2.0 Pitch R/A Wire To Board Fitting Nail(H=5.7)	铜合金/表面镀锡 Copper Alloy/ Tin Plating
④	2.0 R型立式WTB吸盖 2.0 Pitch S/T Wire To Board Cover(H=8.7)	LCP UL94V-0 黑色/本色

MANUFACTURE DWG

东莞市讯普电子科技有限公司
DongGuan XunPu Electronics Co., LtdUNLESS OTHERWISE
SPECIFIED TOLERANCES

TITLE:

2.00 Pitch R型立式WTB

PAR

PA2.0-NPLT-MR

DWN

Lucas

CHKD

Ethan

APVD

Jacob

SCALE:1:1

UNIT:MM

SIZE:A4

SHEET:1F1

REV:A

DECIMALS:

X.:±0.50

X.X:±0.20

X.XX:±0.10

ANGLES:

±1°

CUSTOMER COPY

J